# UNISONIC TECHNOLOGIES CO., LTD

3N65-HC **Power MOSFET** 

# 3A, 650V N-CHANNEL **POWER MOSFET**

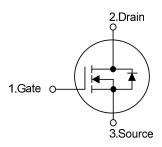
#### DESCRIPTION

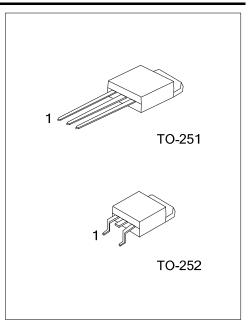
The UTC 3N65-HC is a high voltage power MOSFET designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and high rugged avalanche characteristics. This power MOSFET is usually used in high speed switching applications of switching power supplies and adaptors.

#### **FEATURES**

- \*  $R_{DS(ON)}$  < 4.0  $\Omega$  @  $V_{GS}$ =10V,  $I_{D}$ =1.5A
- \* Fast switching capability
- \* Avalanche energy tested
- \* Improved dv/dt capability, high ruggedness

#### **SYMBOL**

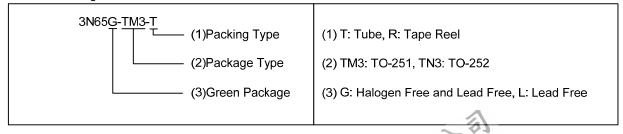




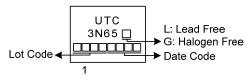
#### **ORDERING INFORMATION**

Ordering Number		Doolsone	Pin Assignment			Daakina	
Lead Free	Halogen Free	Package	1	2	3	Packing	
3N65L-TM3-T	3N65G-TM3-T	TO-251	G	D	S	Tube	
3N65L-TN3-R	3N65G-TN3-R	TO-252	G	D	S	Tape Reel	

Note: Pin Assignment: G: Gate D: Drain S: Source



# **MARKING**



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#### **ABSOLUTE MAXIMUM RATINGS** (T<sub>C</sub> = 25°C, unless otherwise specified)

PARAMETER	SYMBOL	RATINGS	UNIT
Drain-Source Voltage	$V_{DSS}$	650	<b>V</b>
Gate-Source Voltage	$V_{GSS}$	±30	V
Continuous Drain Current	$I_{D}$	3	Α
Pulsed Drain Current (Note 2)	$I_{DM}$	6	Α
Avalanche Energy Single Pulsed (Note 3)	E <sub>AS</sub>	108	mJ
Peak Diode Recovery dv/dt (Note 4)	dv/dt	2.7	V/ns
Power Dissipation	$P_{D}$	56	W
Junction Temperature	$T_J$	+150	°C
Storage Temperature	$T_{STG}$	-55 ~ <b>+</b> 150	°C

- Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.
  - 2. Repetitive Rating: Pulse width limited by maximum junction temperature.
  - 3. L = 60mH,  $I_{AS}$  = 1.9A,  $V_{DD}$  = 50V,  $R_{G}$  = 25  $\Omega$ , Starting  $T_{J}$  = 25°C
  - 4.  $I_{SD} \le 3.0 A$ , di/dt  $\le 200 A/\mu s$ ,  $V_{DD} \le BV_{DSS}$ , Starting  $T_J = 25 ^{\circ}C$

#### **THERMAL DATA**

PARAMETER	SYMBOL	RATING	UNIT
Junction to Ambient	$\theta_{JA}$	62.5	°C/W
Junction to Case	θ <sub>JC</sub>	2.2	°C/W

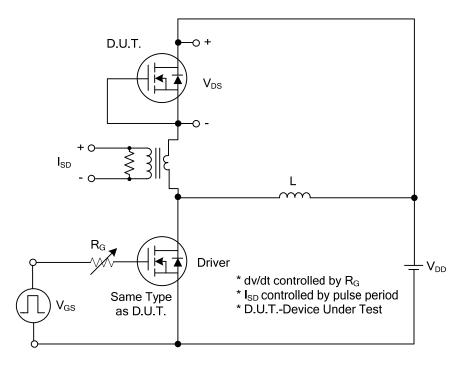
#### **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> =25°C, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV <sub>DSS</sub>	$V_{GS} = 0V, I_D = 250\mu A$	650			V
Drain-Source Leakage Current		I <sub>DSS</sub>	$V_{DS} = 650V, V_{GS} = 0V$			10	μΑ
Gate- Source Leakage Current	Forward	lass	$V_{GS} = 30V$ , $V_{DS} = 0V$			100	nA
	Reverse	$I_{GSS}$	$V_{GS} = -30V, V_{DS} = 0V$			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.0		4.0	V
Static Drain-Source On-State Resistance		R <sub>DS(ON)</sub>	$V_{GS} = 10V, I_D = 1.5A$			4.0	Ω
DYNAMIC CHARACTERISTICS							
Input Capacitance	put Capacitance				278		pF
Output Capacitance		Coss	V <sub>DS</sub> =25V, V <sub>GS</sub> =0V, f=1.0MHz		50		pF
Reverse Transfer Capacitance		$C_{RSS}$			12		pF
SWITCHING CHARACTERISTIC	S						
Total Gate Charge (Note 1)		$Q_G$	V <sub>DS</sub> =200V, V <sub>GS</sub> =10V, I <sub>D</sub> =2.0A		15		nC
Gate-Source Charge		$Q_{GS}$	I <sub>G</sub> =1mA (Note 1, 2)		3.6		nC
Gate-Drain Charge		$Q_GD$	IG-IIIA (Note 1, 2)		4.6		nC
Turn-On Delay Time (Note 1)		t <sub>D(ON)</sub>			30		ns
Turn-On Rise Time		t <sub>R</sub>	$V_{DS}$ =30V, $V_{GS}$ =10V, $I_{D}$ =0.5A,		57		ns
Turn-Off Delay Time		t <sub>D(OFF)</sub>	R <sub>G</sub> =25Ω (Note 1, 2)		120		ns
Turn-Off Fall Time		t <sub>F</sub>			60		ns
DRAIN-SOURCE DIODE CHARA	CTERISTICS	AND MAXII	MUM RATINGS ~				
Maximum Body-Diode Continuous Current		Is	10, V 0	W		3	Α
Maximum Body-Diode Pulsed Current		I <sub>SM</sub>	K PV a CO			6	Α
Drain-Source Diode Forward Voltage (Note 1)		$V_{SD}$	$I_S=3.0A$ , $V_{GS}=0V$			1.4	V
Reverse Recovery Time (Note 1)		t <sub>rr</sub>	I <sub>S</sub> =3.0A , V <sub>GS</sub> =0V		324		ns
Reverse Recovery Charge		Qm	di/dt=100A/µs		1.68		μC

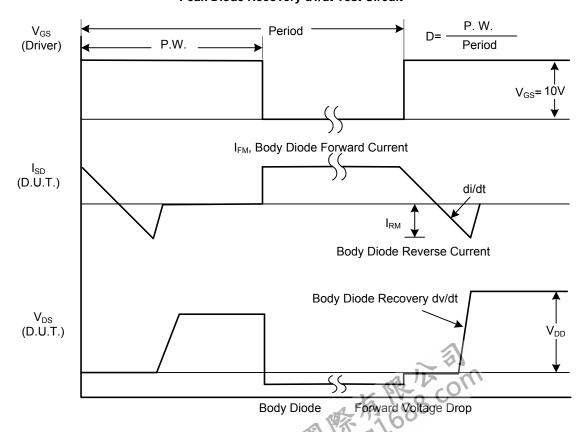
Notes: 1. Pulse Test: Pulse width ≤ 300µs, Duty cycle ≤ 2%.
2. Essentially independent of operating temperature.

3N65-HC Power MOSFET

#### **■ TEST CIRCUITS AND WAVEFORMS**



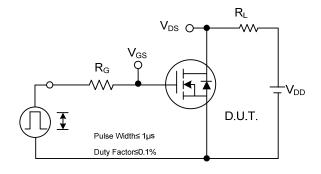
Peak Diode Recovery dv/dt Test Circuit

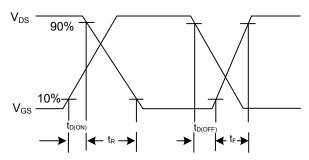


Peak Diode Recovery dv/dt Waveforms

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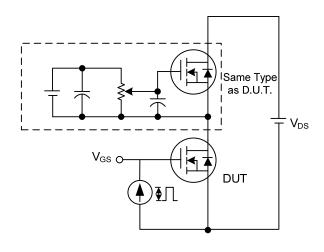
#### **TEST CIRCUITS AND WAVEFORMS**

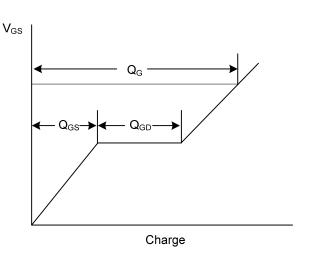




**Switching Test Circuit** 

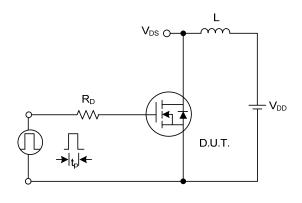
**Switching Waveforms** 

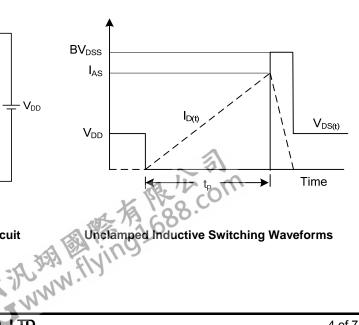




**Gate Charge Test Circuit** 

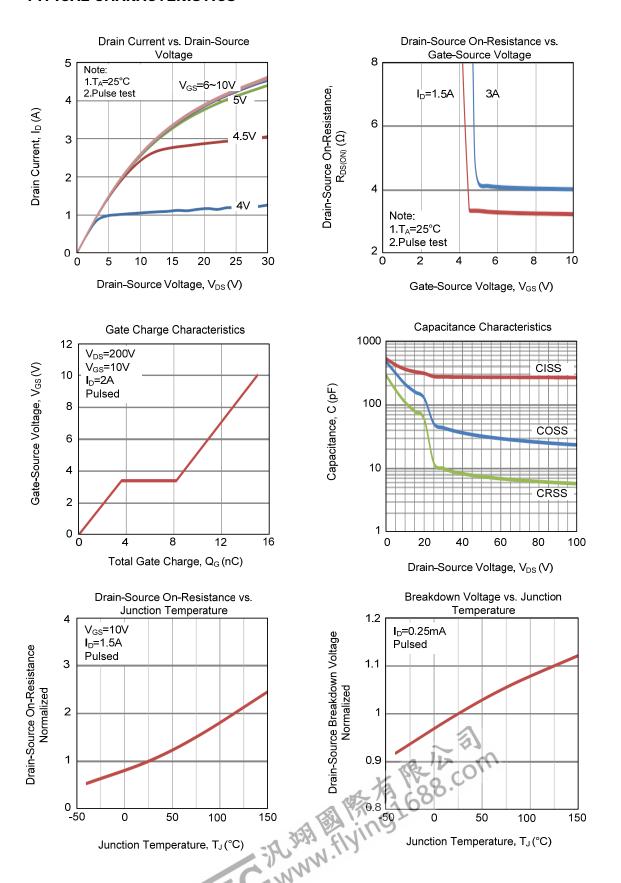
**Gate Charge Waveform** 



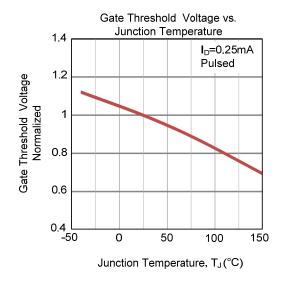


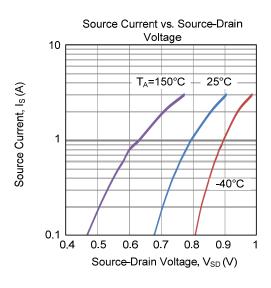
**Unclamped Inductive Switching Test Circuit** 

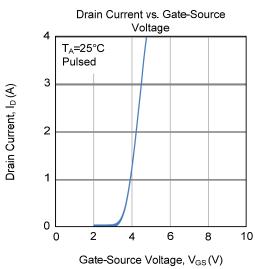
#### **■ TYPICAL CHARACTERISTICS**

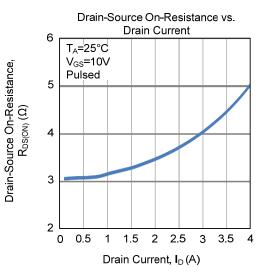


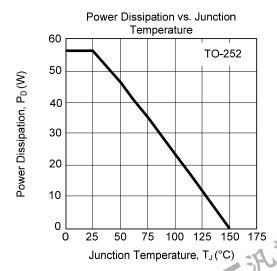
## ■ TYPICAL CHARACTERISTICS (Cont.)

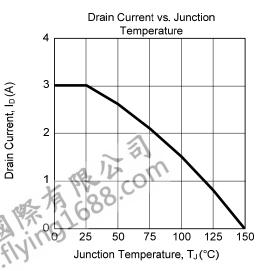




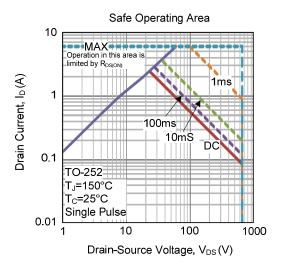








## **■ TYPICAL CHARACTERISTICS (Cont.)**



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